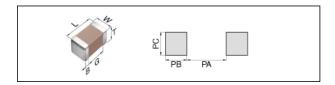
Creation Date: December 16, 2014

C3225X7R1E475M200AA (TDK item description : C3225X7R1E475MT****)

Applications Commercial Grade

Feature General (Up to 50V)

Series C3225 [EIA CC1210]











Size	
Length(L)	3.20mm +/-0.40mm
Width(W)	2.50mm +/-0.30mm
Thickness(T)	2.00mm +/-0.20mm
Terminal Width(B)	0.20mm Min.
Terminal Spacing(G)	
Recommended Land Pattern(PA)	2.00 to 2.40mm
Recommended Land Pattern(PB)	1.00 to 1.20mm
Recommended Land Pattern(PC)	1.90 to 2.50mm
Recommended Slit Pattern(SD)	

Electrical Characteristics	
Capacitance	4.7uF +/-20%
Rated Voltage	25Vdc
Temperature Characteristic	X7R(+/-15%)
Dissipation Factor	3% Max.
Insulation Resistance	106MΩ Min.

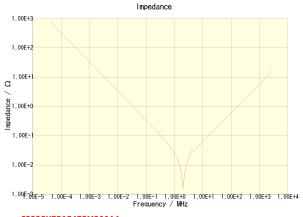
Other	
Soldering Method	Reflow
AEC Q200	No
Packing	Blister (Plastic)Taping [180mm Reel]
Package Quantity	1000Pcs Min.

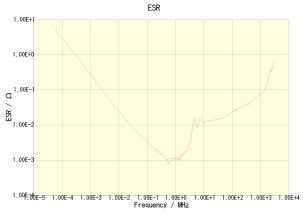
 $[\]bullet \mbox{This PDF}$ document was created based on the data listed on the TDK Corporation website.

[•]All specifications are subject to change without notice.

C3225X7R1E475M200AA

Characteristic Graphs (This is reference data, and does not guarantee the product's characteristics.)

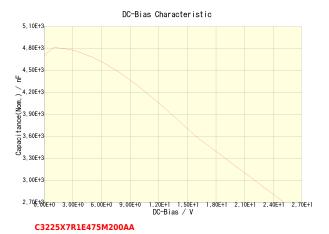




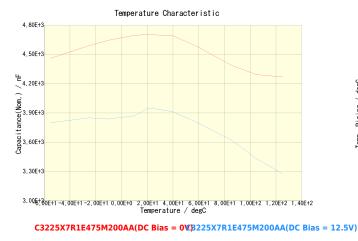
C3225X7R1E475M200AA

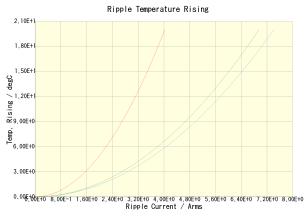












C3225X7R1E475M200AA(100kHz) C3225X7R1E475M200AA(500kHz)

C3225X7R1E475M200AA(1MHz)

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